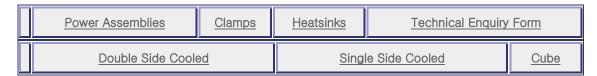
## Power Assemblies - Clamps - Double Side Cooled

Please select product type required from the options below.



To achieve optimum performance and to ensure safe operation, disc semiconductor devices require application of the correct clamping force. The correct clamping force for a device is given in the device datasheet.

The clamp outlines shown in this section are intended to give an overall impression of size and shape, and they should not be scaled for more detailed design purposes.

Full engineering drawings may be obtained from Customer Services : Tel : +44 (0)1522 502901 / 502753 or Email : <a href="mailto:power\_solutions@dynexsemi.com">power\_solutions@dynexsemi.com</a>

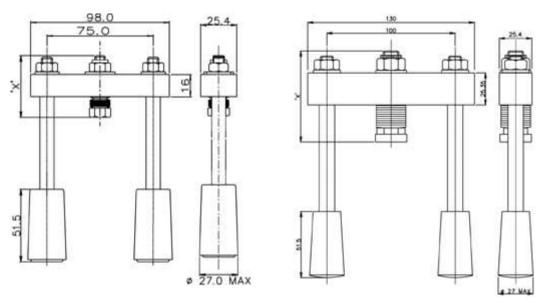
## Clamp Part Numbers



When determining the length of tie rods / bolts required, the following can be used as an approximation: 45 + Dim X + 2(heatsink web thickness) + device thickness

Bolts can be supplied in increments of 5mm.

## **Double Side Cooled Clamp Outlines**

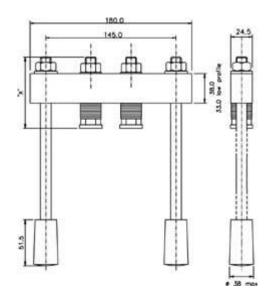


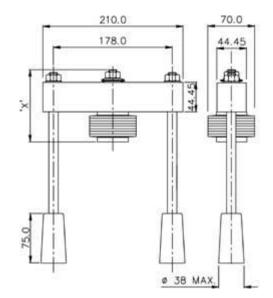
## 31053A2-XXXX-XXX: 75mm centres

Load (kN)	Dim 'X'	Load (kN)	Dim 'X'
2.75 / 3.5 / 4.5 / 5.0 / 5.5	42.6	10 / 12.5	68

30504A2-XXXX-XXX: 100mm centres

8.0 / 9.0	45.5	19.5 / 22	72
9.5 / 10.0 / 11.0 / 12.0 / 12.5 / 15.0	51.5		





17331A2-XXXX-XXX : 145mm centres

32101A2-XXXX-XXX : 178mm centres

Load (kN)	Dim 'X'	Load (kN)	Dim 'X'
20	72	83	110
30 / 32 / 35 / 43	92		
Low Profile			
32/35/43	72		

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